



## **SPECIFICATION** (Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL03C090CA3GNNH

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 9pF, 25V, ±0.25pF, C0G, 0201

## A. Samsung Part Number

<u>CL</u> <u>03</u> <u>C</u> <u>090</u> <u>C</u> <u>A</u> <u>3</u> <u>G</u> <u>N</u> <u>N</u> <u>H</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0201 (inch code)	L: 0.6 ± 0.03 mm	W: 0.3 ± 0.03 mm
3 Dielectric	C0G	8 Inner electrode	Cu
Capacitance	<b>9</b> pF	Termination	Cu
⑤ Capacitance	<b>±0.25</b> pF	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Normal
6 Rated Voltage	25 V	Special	Reserved for future use
7 Thickness	$0.3 \pm 0.03$ mm	① Packaging	Cardboard Type, 7" reel

## **B. Samsung Reliability Test and Judgement condition**

	Performance	Test condition	
Capacitance	Within specified tolerance	1M±10% 0.5~5Vrms	
Q	580 min		
Insulation	More than 500Mohm⋅μF	Rated Voltage 60~120 sec.	
Resistance			
Appearance	No abnormal exterior appearance	Visual inspection	
Withstanding	No dielectric breakdown or	300% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	COG	•	
Characteristics	(From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃)		
Adhesive Strength	No peeling shall be occur on the	200g·F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change: within ±0.5pF	Bending to the limit (1mm)	
		with 1.0mm/sec.	
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5℃, 3±0.3sec.	
		(preheating : 80~120 ℃ for 10~30sec.)	
Resistance to	Capacitance change: within ±0.25pF	Solder pot : 270±5℃, 10±1sec.	
Soldering heat	Tan δ, IR : initial spec.		

	Performance	Test condition
Vibration Test	Capacitance change: within ±0.25pF	Amplitude: 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±0.75pF	With rated voltage
Resistance	Q: 130 min	40±2℃, 90~95%RH, 500+12/-0 hours
	IR : More than 25‰ ⋅ μF	
High Temperature	Capacitance change: within ±0.3pF	With 200% of the rated voltage
Resistance	Q: 290 min	Max. operating temperature
	IR : More than $50  \mathrm{M}\Omega \cdot \mu \mathrm{F}$	1000+48/-0 hours
Temperature	Capacitance change: within ±0.25pF	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C
		→ Max. operating temperature → 25°C
		5 cycles test

## C. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )



A Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.